

TC74LCX574F, TC74LCX574FT, TC74LCX574FK

Low-Voltage Octal D-Type Flip-Flop with 5-V Tolerant Inputs and Outputs

The TC74LCX574 is a high-performance CMOS octal D-type flip-flop. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

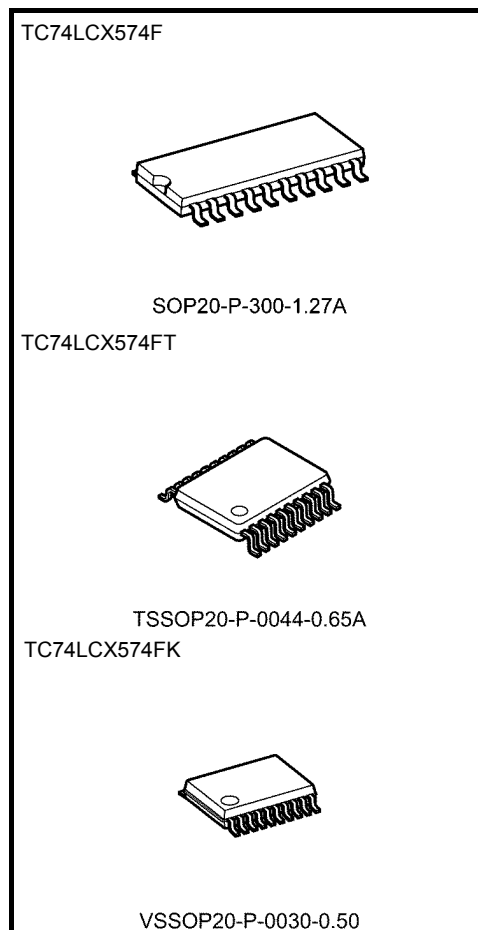
The device is designed for low-voltage (3.3 V) VCC applications, but it could be used to interface to 5 V supply environment for both inputs and outputs.

This 8-bit D-type flip-flop is controlled by a clock input (CK) and an output enable input ($\overline{OE}$). When the $\overline{OE}$ input is high, the eight outputs are in a high-impedance state.

All inputs are equipped with protection circuits against static discharge.

Features

- Low-voltage operation: $V_{CC} = 1.65$ to 3.6 V
- High-speed operation: $t_{pd} = 8.5$ ns (max) ($V_{CC} = 3.0$ to 3.6 V)
- Output current: $|I_{OH}|/I_{OL} = 24$ mA (min) ($V_{CC} = 3.0$ V)
- Latch-up performance: $>\pm 500$ mA
- Available in JEITA SOP, TSSOP and VSSOP (US)
- Power-down protection provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 574 type

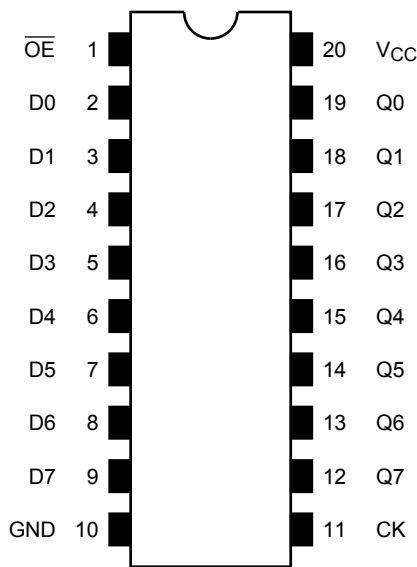


Weight

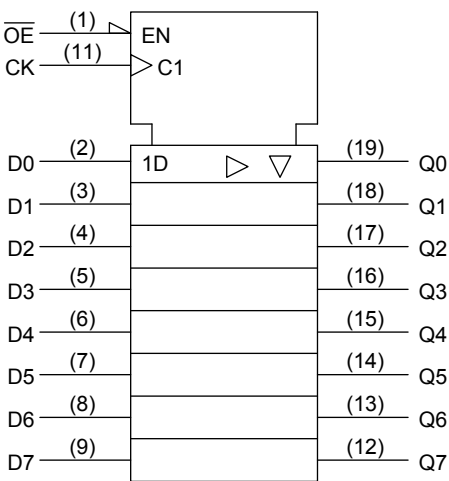
SOP20-P-300-1.27A	: 0.22 g (typ.)
TSSOP20-P-0044-0.65A	: 0.08 g (typ.)
VSSOP20-P-0030-0.50	: 0.03 g (typ.)

Note: The Electrical Characteristics of $V_{CC}=1.8\pm 0.15$ V is only applicable for products which manufactured from January 2009 onward.

Pin Assignment (top view)



IEC Logic Symbol



Truth Table

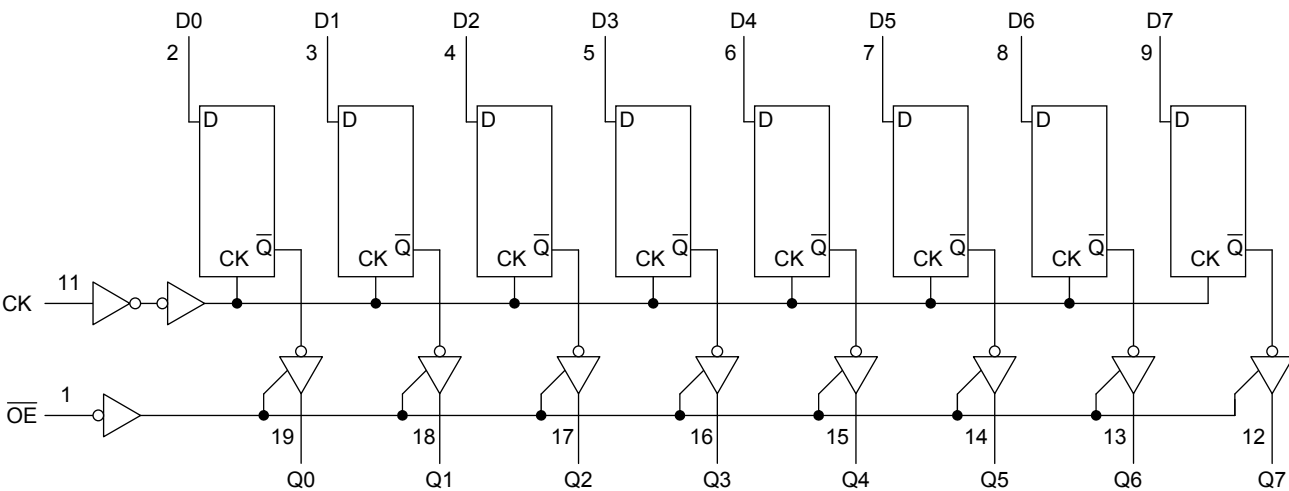
Inputs			Outputs
OE	CK	D	
H	X	X	Z
L		X	Qn
L		L	L
L		H	H

X: Don't care

Z: High impedance

Qn: No change

System Diagram



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	V_{CC}	-0.5 to 7.0	V
DC input voltage	V_{IN}	-0.5 to 7.0	V
DC output voltage	V_{OUT}	-0.5 to 7.0 (Note 2)	V
		-0.5 to $V_{CC} + 0.5$ (Note 3)	
Input diode current	I_{IK}	-50	mA
Output diode current	I_{OK}	± 50 (Note 4)	mA
DC output current	I_{OUT}	± 50	mA
Power dissipation	P_D	180	mW
DC V_{CC} /ground current	I_{CC}/I_{GND}	± 100	mA
Storage temperature	T_{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in OFF state

Note 3: High or low state. I_{OUT} absolute maximum rating must be observed.

Note 4: $V_{OUT} < GND$, $V_{OUT} > V_{CC}$

Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit
Power supply voltage	V_{CC}	1.65 to 3.6	V
		1.5 to 3.6 (Note 2)	
Input voltage	V_{IN}	0 to 5.5	V
Output voltage	V_{OUT}	0 to 5.5 (Note 3)	V
		0 to V_{CC} (Note 4)	
Output current	I_{OH}/I_{OL}	± 24 (Note 5)	mA
		± 12 (Note 6)	
Operating temperature	T_{opr}	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 10 (Note 7)	ns/V

Note 1: The operating ranges must be maintained to ensure the normal operation of the device.
Unused inputs must be tied to either V_{CC} or GND.

Note 2: Data retention only

Note 3: Output in OFF state

Note 4: High or low state

Note 5: $V_{CC} = 3.0$ to 3.6 V

Note 6: $V_{CC} = 2.7$ to 3.0 V

Note 7: $V_{IN} = 0.8$ to 2.0 V, $V_{CC} = 3.0$ V

Electrical Characteristics
DC Characteristics (Ta = -40 to 85°C)

Characteristics		Symbol	Test Condition			Min	Max	Unit
					V _{CC} (V)			
Input voltage	H-level	V _{IH}	—		1.65 to 2.3	V _{CC} × 0.9	—	V
					2.3 to 2.7	1.7	—	
					2.7 to 3.6	2.0	—	
	L-level	V _{IL}	—		1.65 to 2.3	—	V _{CC} × 0.1	
					2.3 to 2.7	—	0.7	
					2.7 to 3.6	—	0.8	
Output voltage	H-level	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = −100 μA	1.65 to 3.6	V _{CC} −0.2	—	V
				I _{OH} = −4 mA	1.65	1.05	—	
				I _{OH} = −8 mA	2.3	1.7	—	
				I _{OH} = −12 mA	2.7	2.2	—	
				I _{OH} = −18 mA	3.0	2.4	—	
				I _{OH} = −24 mA	3.0	2.2	—	
	L-level	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 100 μA	1.65 to 3.6	—	0.2	
				I _{OL} = 4 mA	1.65	—	0.45	
				I _{OL} = 8 mA	2.3	—	0.7	
				I _{OL} = 12 mA	2.7	—	0.4	
				I _{OL} = 16 mA	3.0	—	0.4	
				I _{OL} = 24 mA	3.0	—	0.55	
Input leakage current		I _{IN}	V _{IN} = 0 to 5.5 V	1.65 to 3.6	—	±5.0	μA	
3-state output off-state current		I _{OZ}	V _{IN} = V _{IH} or V _{IL} V _{OUT} = 0 to 5.5 V	1.65 to 3.6	—	±5.0	μA	
Power off leakage current		I _{OFF}	V _{IN} /V _{OUT} = 5.5 V	0	—	10.0	μA	
Quiescent supply current		I _{CC}	V _{IN} = V _{CC} or GND	1.65 to 3.6	—	10.0	μA	
			V _{IN} /V _{OUT} = 3.6 to 5.5 V	1.65 to 3.6	—	±10.0		
Increase in I _{CC} per input		ΔI _{CC}	V _{IH} = V _{CC} − 0.6 V	2.7 to 3.6	—	500		

AC Characteristics (Ta = -40 to 85°C)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
Maximum clock frequency	f _{max}	Figure 1, Figure 2	1.8±0.15	50	—	MHz
			2.5±0.2	100	—	
			2.7	100	—	
			3.3 ± 0.3	150	—	
Propagation delay time (CK-Q)	t _{pLH} t _{pHL}	Figure 1, Figure 2	1.8±0.15	—	30.0	ns
			2.5±0.2	—	10.5	
			2.7	—	9.5	
			3.3 ± 0.3	1.5	8.5	
Output enable time	t _{pZL} t _{pZH}	Figure 1, Figure 3	1.8±0.15	—	34.0	ns
			2.5±0.2	—	17.0	
			2.7	—	9.5	
			3.3 ± 0.3	1.5	8.5	
Output disable time	t _{pLZ} t _{pHZ}	Figure 1, Figure 3	1.8±0.15	—	28.0	ns
			2.5±0.2	—	14.0	
			2.7	—	7.0	
			3.3 ± 0.3	1.5	6.5	
Minimum pulse width (CK)	t _w (H) t _w (L)	Figure 1, Figure 2	1.8±0.15	10.0	—	ns
			2.5±0.2	5.0	—	
			2.7	3.3	—	
			3.3 ± 0.3	3.3	—	
Minimum set-up time	t _s	Figure 1, Figure 2	1.8±0.15	10.0	—	ns
			2.5±0.2	5.0	—	
			2.7	2.5	—	
			3.3 ± 0.3	2.5	—	
Minimum hold time	t _h	Figure 1, Figure 2	1.8±0.15	1.5	—	ns
			2.5±0.2	1.5	—	
			2.7	1.5	—	
			3.3 ± 0.3	1.5	—	
Output to output skew	t _{osLH} t _{osHL}	(Note)	2.7	—	—	ns
			3.3 ± 0.3	—	1.0	

Note: Parameter guaranteed by design.

(t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLm} - t_{pHLn}|)

Dynamic Switching Characteristics (Ta= 25°C, input: tr = tf = 2.5 ns, CL= 50 pF, RL= 500 Ω)

Characteristics	Symbol	Test Condition	VCC (V)	Typ.	Unit
Quiet output maximum dynamic VOL	VOLP	VIH = 3.3 V, VIL = 0 V	3.3	0.8	V
Quiet output minimum dynamic VOL	VOLV	VIH = 3.3 V, VIL = 0 V	3.3	0.8	V

Capacitive Characteristics (Ta = 25°C)

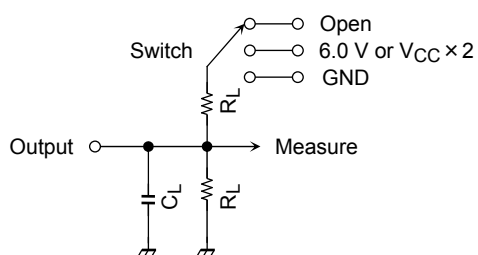
Characteristics	Symbol	Test Condition	VCC (V)	Typ.	Unit
Input capacitance	CIN	—	3.3	7	pF
Output capacitance	COUT	—	3.3	8	pF
Power dissipation capacitance	CPD	fIN = 10 MHz (Note)	3.3	25	pF

Note: CPD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

Average operating current can be obtained by the equation:

$$I_{CC}(\text{opr}) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$$

AC Test Circuit



Parameter	Switch
tPLH, tPHL	Open
tPLZ, tPZL	6.0 V @ VCC = 3.3±0.3V
	@ VCC = 2.7V
	VCC x 2 @ VCC = 2.5±0.2V
	@ VCC = 1.8±0.15V
tPHZ, tPZH	GND

Figure 1

AC Waveform

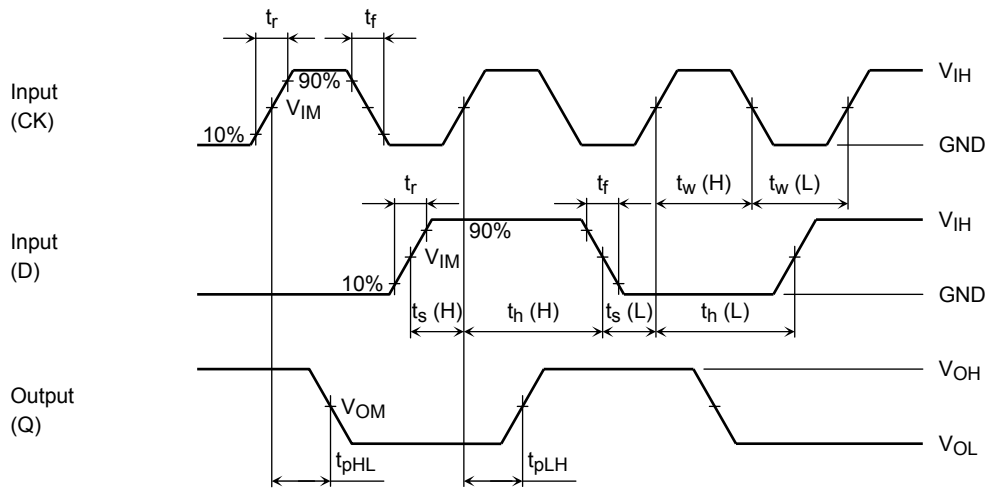


Figure 2 t_{pLH} , t_{pHL} , t_w , t_s , t_h

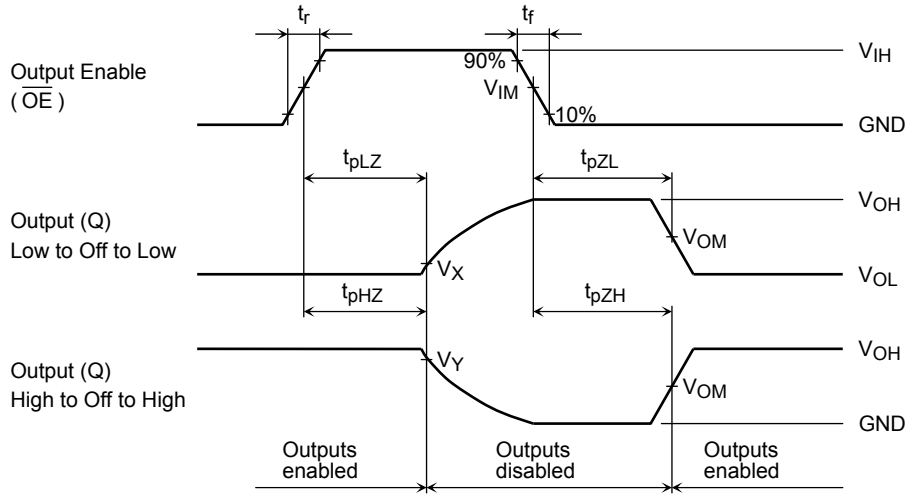


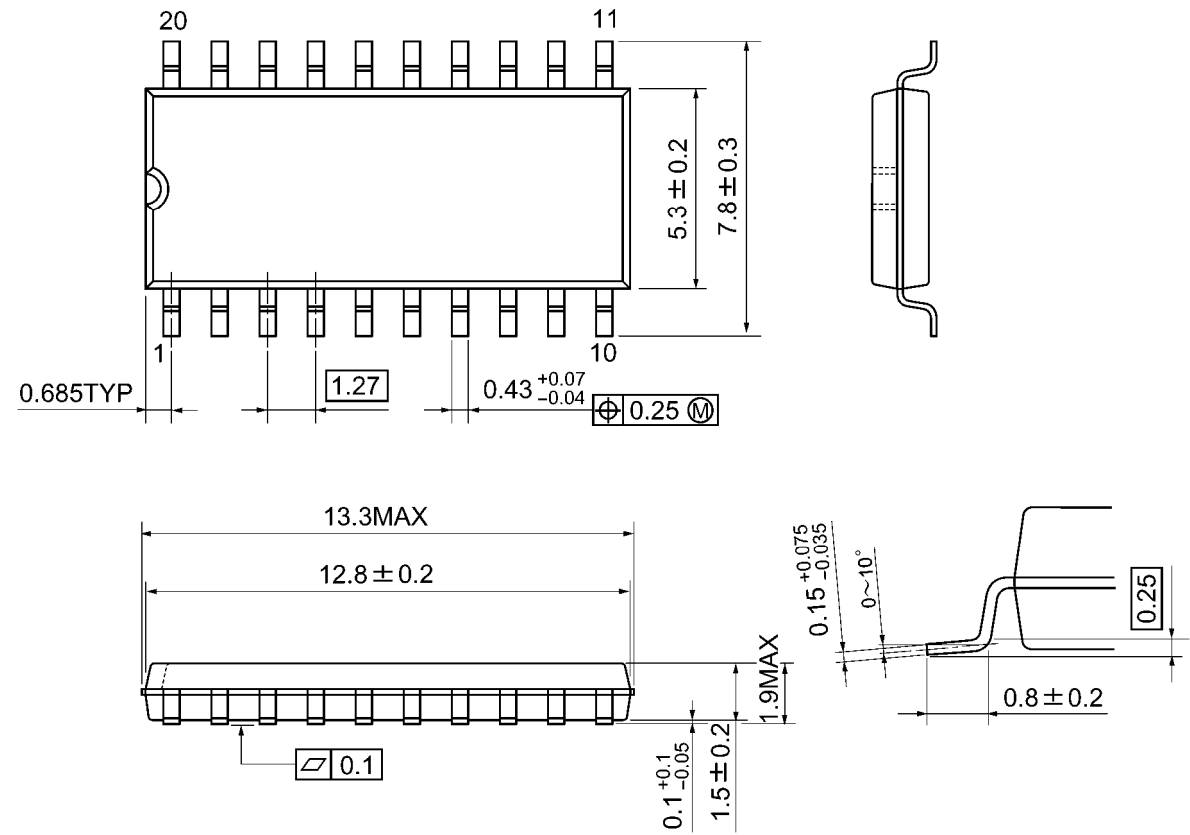
Figure 3 t_{pLZ} , t_{pHZ} , t_{pZL} , t_{pZH}

	Symbol	V_{CC}		
		$3.3 \pm 0.3 \text{ V}$ 2.7V	$2.5 \pm 0.2 \text{ V}$	$1.8 \pm 0.15 \text{ V}$
Input	V_{IH}	2.7V	V_{CC}	V_{CC}
	V_{IM}	1.5V	$V_{CC}/2$	$V_{CC}/2$
	t_r, t_f	2.5ns	2.0ns	2.0ns
Output	V_{OM}	1.5V	$V_{OH}/2$	$V_{OH}/2$
	V_X	$V_{OL} + 0.3\text{V}$	$V_{OL} + 0.15\text{V}$	$V_{OL} + 0.15\text{V}$
	V_Y	$V_{OH} - 0.3\text{V}$	$V_{OH} - 0.15\text{V}$	$V_{OH} - 0.15\text{V}$
Load	C_L	50pF	30pF	30pF
	R_L	500 Ω	500 Ω	1k Ω

Package Dimensions

SOP20-P-300-1.27A

Unit: mm

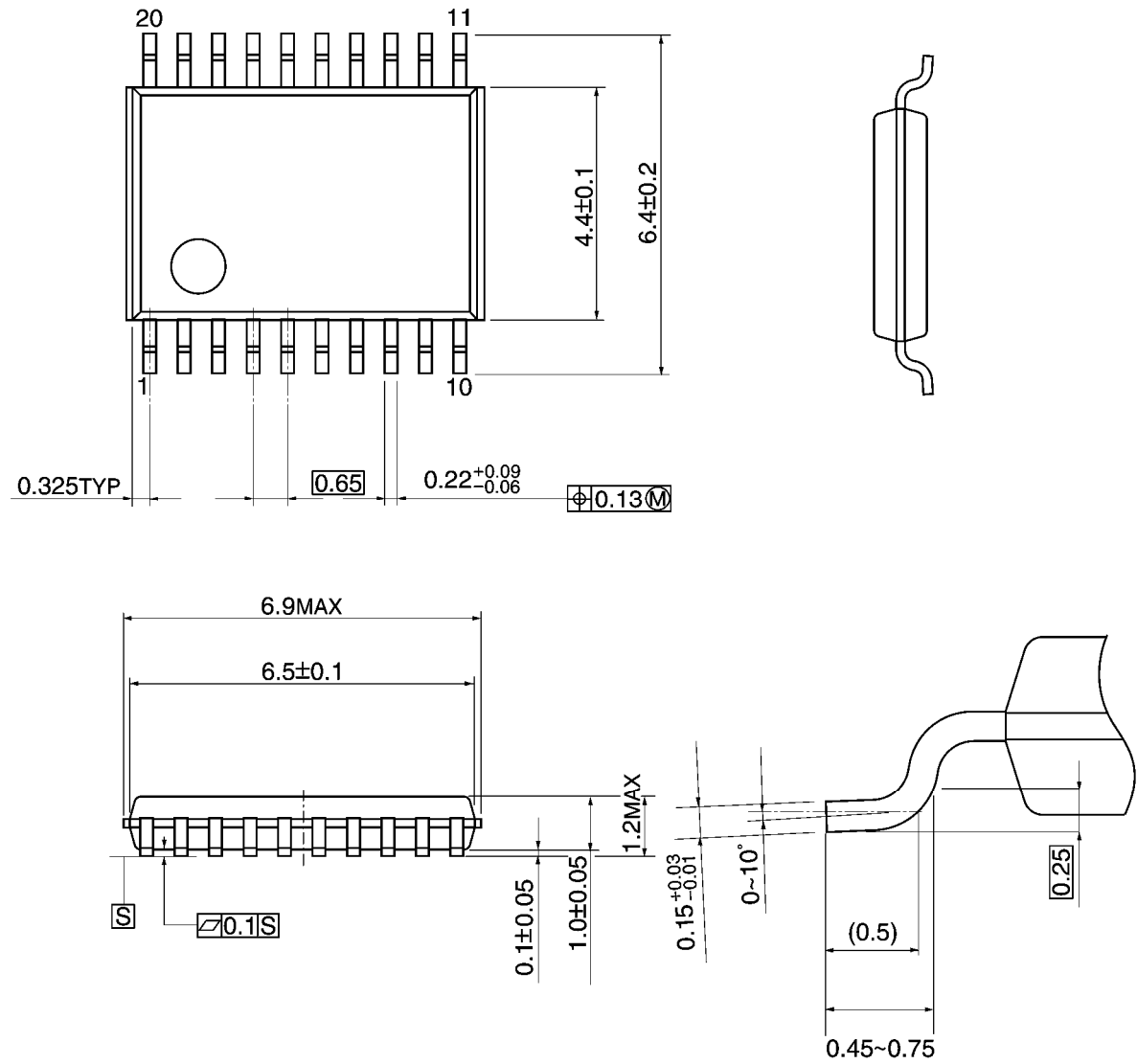


Weight: 0.22 g (typ.)

Package Dimensions

TSSOP20-P-0044-0.65A

Unit: mm

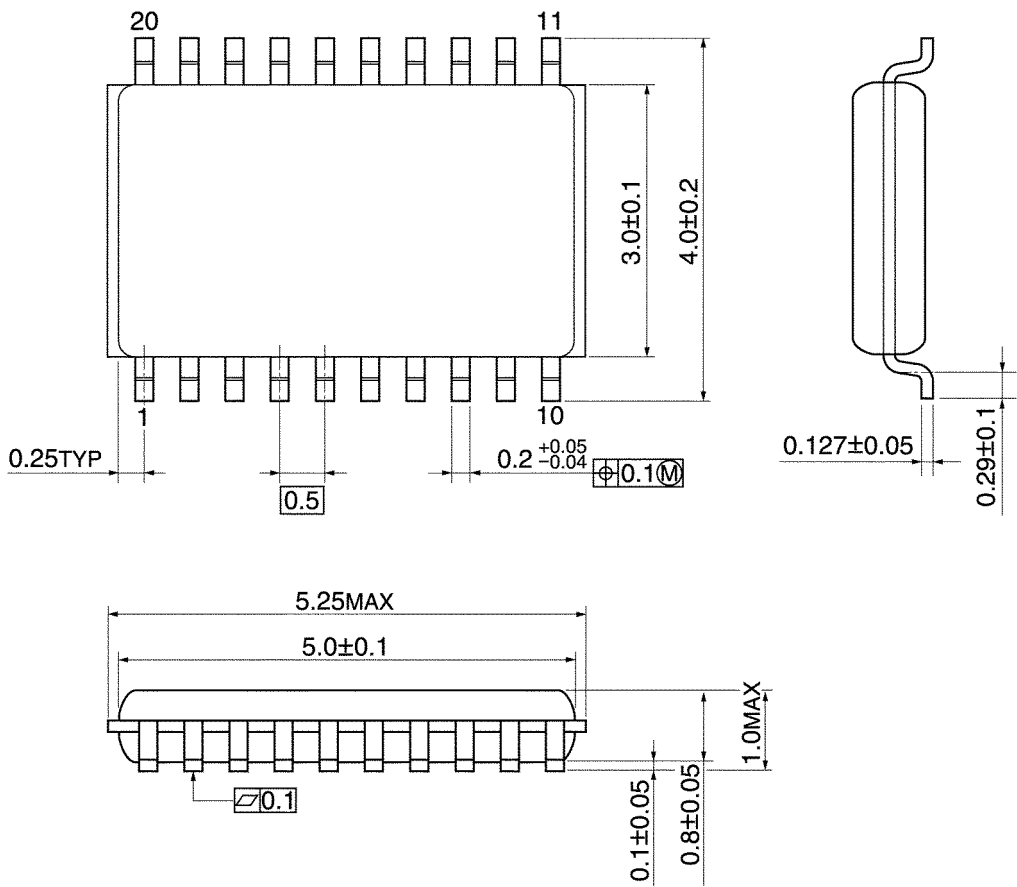


Weight: 0.08 g (typ.)

Package Dimensions

VSSOP20-P-0030-0.50

Unit: mm



Weight: 0.03 g (typ.)

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